

ESD Protection Diode Array

Low Capacitance ESD Protection Diode for High Speed Data Line

ESD1014

The ESD1014 surge protection is designed to protect high speed data lines from ESD, EFT, and lightning.

Features

- Low Capacitance (6 pF Maximum Between I/O Lines and GND)
- ESD Rating of Class 3B (Exceeding 8 kV) per Human Body model and Class C (Exceeding 400 V) per Machine Model
- Protection for the Following IEC Standards:
IEC 61000-4-2 (ESD) Level 4 – 30 kV (Contact)
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- This is a Pb-Free Device

Typical Applications

- High Speed Communication Line Protection
- USB 1.1 and 2.0 Power and Data Line Protection
- Digital Video Interface (DVI)
- Monitors and Flat Panel Displays
- T1/E1 and T3/E3
- 10/100/1000 Ethernet Protection
- Gigabit Ethernet Protection

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

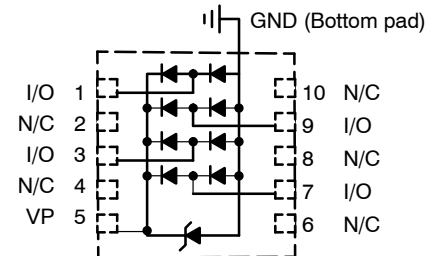
Rating	Symbol	Value	Unit
Peak Power Dissipation (Note 1)	P_{pk}	450	W
Maximum Peak Pulse Current (Note 1)	I_{pp}	30	A
Operating Junction Temperature Range	T_J	-40 to +125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55 to +150	$^\circ\text{C}$
Lead Solder Temperature – Maximum (10 Seconds)	T_L	260	$^\circ\text{C}$
Machine Model (MM) Human Body Model (HBM) IEC 61000-4-2 Contact (ESD)	ESD	0.4 16 30	kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. 8/20 μs Waveform per Figure 2 (@ $T_A = 25^\circ\text{C}$).

LOW CAPACITANCE DIODE SURGE PROTECTION ARRAY

PIN CONFIGURATION AND SCHEMATIC



UDFN10
CASE 517AN

MARKING DIAGRAM



- 1014 = Specific Device Code
A = Assembly Location
Y = Year
W = Work Week
■ = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
ESD1014MUTAG	UDFN10 (Pb-Free)	3000 / Tape & Reel
SZESD1014MUTAG	UDFN10 (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}	(Note 2)			3.3	V
Breakdown Voltage	V_{BR}	$I_T = 1\text{ mA}$, (Note 3)	5.0	5.3		V
Reverse Leakage Current	I_R	$V_{RWM} = 3.3\text{ V}$			5.0	μA
Clamping Voltage	V_C	Pin 5 to GND, $I_{PP} = 1\text{ A}$			6.2	V
Clamping Voltage	V_C	Any I/O pin to GND $I_{PP} = 1\text{ A}$ $I_{PP} = 10\text{ A}$ $I_{PP} = 25\text{ A}$			7.5 9.0 11	V
Maximum Peak Pulse Current	I_{PP}	8/20 μs Waveform per Figure 2			30	A
Junction Capacitance	C_J	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$ between I/O Pins and GND		3.8	5.0	pF
		$V_R = 0\text{ V}$, $f = 1\text{ MHz}$ between I/O Pins		1.5	3.0	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- Surge protection devices are normally selected according to the working peak reverse voltage (V_{RWM}), which should be equal or greater than the DC or continuous peak operating voltage level.
- V_{BR} is measured at pulse test current I_T .

TYPICAL PERFORMANCE CURVES

($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

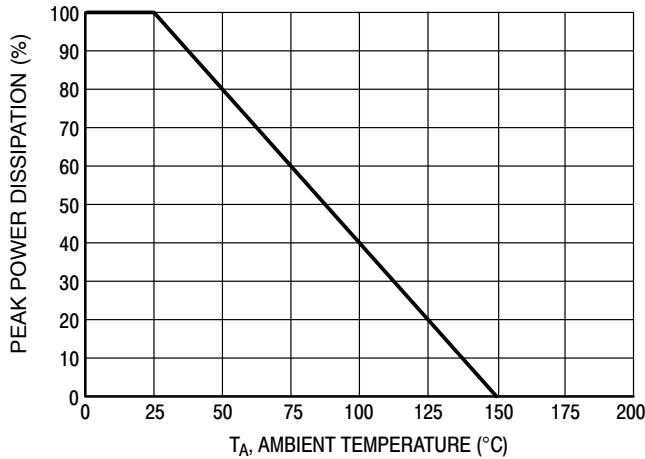


Figure 1. Pulse Derating Curve

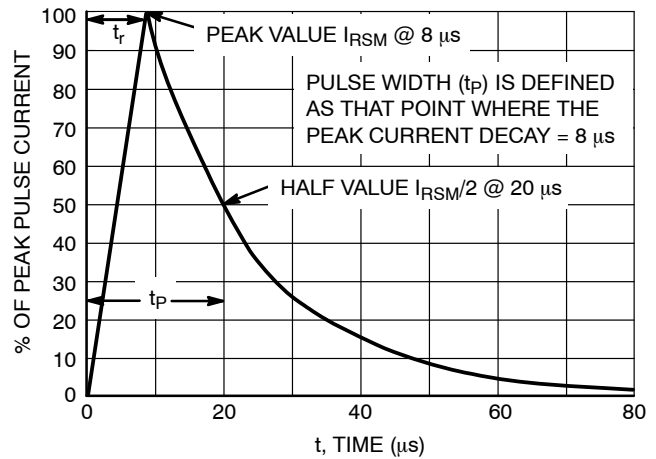


Figure 2. 8/20 μs Pulse Waveform

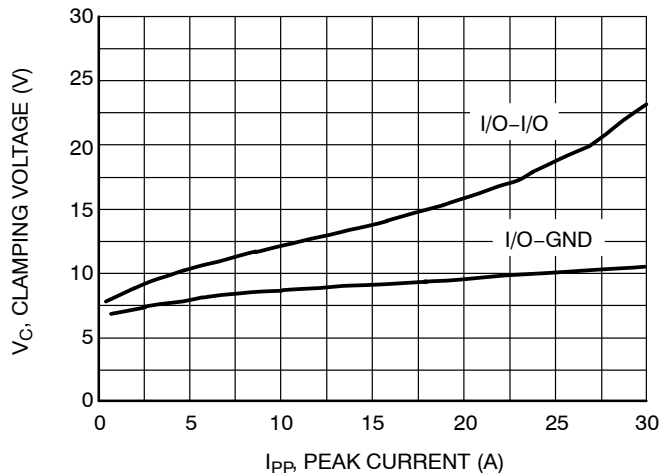


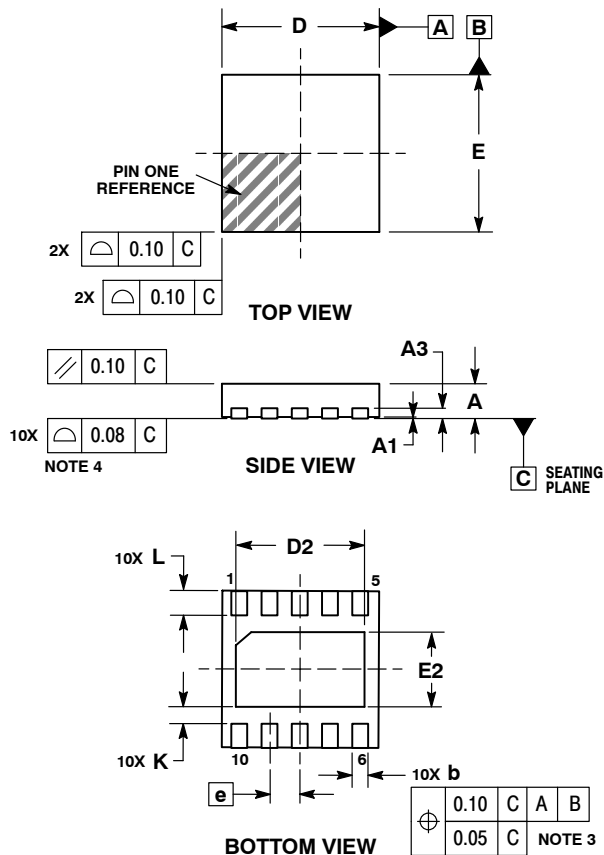
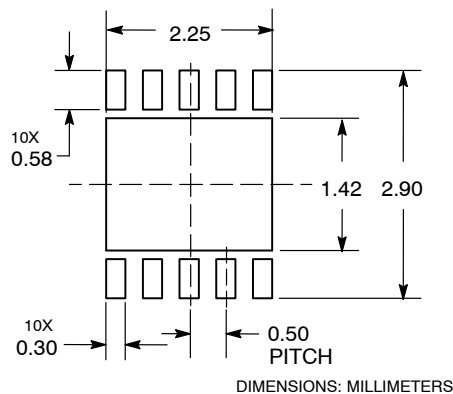
Figure 3. Clamping Voltage, 8/20 μs Waveform



SCALE 2:1

UDFN10 2.6x2.6, 0.5P
CASE 517AN
ISSUE B

DATE 03 OCT 2012


SOLDERING FOOTPRINT*


*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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